

Author Index

A

Ananthasuresh, G. K., [61–70](#), [128](#)

B

Becker, F., [1–9](#)

Bhargav, D. B. S., [61–70](#)

Burlage, K., [113–122](#)

C

Corves, B., [49–60](#)

D

Dehelean, L. M., [101–110](#)

Dehelean, N. M., [101–110](#)

Diez, M., [85–98](#)

G

Gerhardy, C., [113–122](#)

H

Hayashi, T., [11–22](#)

Hernández, A., [85–98](#)

Horie, M., [31–39](#)

Hoshikawa, Y., [31–39](#)

I

Ishimori, S., [11–22](#)

Ito, T., [11–22](#)

Ivanov, I., [49–60](#)

K

Kamiya, D., [31–39](#)

Kito, Y., [11–22](#)

L

Lovasz, E. Ch., [101–110](#)

M

Minchenya, V., [1–9](#)

N

Nakazato, Y., [23–29](#)

P

Petuya, V., [85–98](#)

Phunopas, A., [11–22](#)

S

Saxena, A., [125–138](#)

Sharma, P., [125–138](#)

Schomburg, W. K., [113–122](#)

Sonobe, Y., [23–29](#)

T

Terada, H., [73–84](#)

Toyama, S., [23–29](#)

U

Urizar, M., [85–98](#)

Y

Yamagata, T., [73–84](#)

Z

Zeidis, I., [1–9](#)

Zentner, L., [41–47](#)

Zimmermann, K., [1–9](#)

Subject Index

A

AMOM, 129–135, 138

B

Bimorph actuator, 74–78, 81

Blood vessel, 23–24, 26–29

C

Capsule, 11–22, 108

Cell-manipulation, 62, 68

Changing the shape and dimension of the links, 36

Cochlear implant, 41–47

Compliant mechanism, 41–47, 61–70, 129

Conducting polymer, 73–84

E

Elastodynamic locomotion, 1

ETC micro mechanisms, 126, 128, 133, 136–138

F

Friction force, 5, 11–14, 16, 18–19

Flexure hinge-based parallel manipulators, 49–60

Flexure hinges, 49–60

H

Hydraulic device, 41–47

Hydraulic pressure, 23–29

I

Injection molding pantograph mechanism, 31–39

In-pipe robot, 23–29

Intracytoplasmic injection, 61–70

K

Kinematics, 49–51, 54, 56, 85–98, 104–105

M

Magnetic force, 12–14, 17–20

Mathematical modelling, 73

Matrix, 45, 53, 101–110, 133

MEMS, 125–138

Micromechanism, 11–22

Micro robot, 1–9, 63

Miniature gripper, 62, 67

O

Optimum design, 31–39

P

Pad, 101–110, 118

Parallel manipulators, 49–60

Peristalsis motion, 23–29

Piezoelectric actuator, 1, 9

Polymer microstructures, 114

Polypyrrole, 74–78, 80

Positioning, 37–38, 49–50, 61, 63, 67, 74, 78–83, 114

Pressure sensor, 102, 106–107

Proteins, 85–98

PWM control, 78

R

Recognition, 101–104, 107

Reduction of joint forces, 32

Remote-haptics, 68

S

Scale effect, [23–24](#)

T

Topology design, [125–138](#)

Transducer, [3](#), [101–110](#), [121](#)

U

Ultrasonic

hot embossing, [113–122](#)

welding, [113–114](#), [116–117](#)

V

Vibration of continua, [1](#)